

# **Excellent Integrated System Limited**

Stocking Distributor

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Samsung Electro-Mechanics America, Inc. CL10C681FB8NNNC

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## Distributor of Samsung Electro-Mechanics America, Inc.: Excellent Integrated System Lin

Datasheet of CL10C681FB8NNNC - CAP CER 680PF 50V NP0 0603

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





## **SPECIFICATION**

• Supplier : Samsung electro-mechanics • Samsung P/N : CL10C681FB8NNNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 680pF, 50V, ±1%, C0G, 0603

#### A. Samsung Part Number

<u>CL</u> <u>10</u> <u>C</u> <u>681</u> <u>F</u> <u>B</u> <u>8</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ 8 ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor							
2	Size	0603 (inch c	ode) L: 1.6	± 0.1	mm	W:	8.0	± 0.1	mm
	Distants	000			4 1 .		NI:		
(3)	Dielectric	C0G	(8)	Inner el	ectrode		Ni		
4	Capacitance	<b>680</b> pF		Termina	ation		Cu		
⑤	Capacitance	±1 %		Plating			Sn 10	0%	(Pb Free)
	tolerance		9	Product	t		Norma	al	
6	Rated Voltage	50 V	10	Special			Reser	ved for	future use
7	Thickness	$0.8 \pm 0.1$	mm ①	Packag	ing		Cardb	oard T	ype, 7" reel

#### B. Samsung Reliablility Test and Judgement condition

	Performance	Test condition					
Capacitance	Within specified tolerance	1Mb±10% 0.5~5Vrms					
Q	1000 min						
Insulation	10,000Mohm or 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.					
Resistance	Whichever is Smaller						
Appearance	No abnormal exterior appearance	Microscope (×10)					
Withstanding	No dielectric breakdown or	300% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	COG						
Characterisitcs	(From -55 $^{\circ}\!$						
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change :	Bending to the limit (1mm)					
	within ±5% or ±0.5pF whichever is larger	with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder					
	is to be soldered newly	245±5℃, 3±0.3sec.					
		(preheating : 80~120℃ for 10~30sec.)					
Resistance to	Capacitance change :	Solder pot : 270±5℃, 10±1sec.					
Soldering heat	within ±2.5% or ±0.25pF whichever is larger						
	Tan δ, IR : initial spec.						



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	Performance	Test condition				
Vibration Test	Capacitance change :	Amplitude : 1.5mm				
	within ±2.5% or ±0.25pF whichever is larger	From 10Hz to 55Hz (return : 1min.)				
	Tan δ, IR : initial spec.	2hours × 3 direction (x, y, z)				
Moisture	Capacitance change :	With rated voltage				
Resistance	within ±7.5% or ±0.75pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs				
	Q: 200 min					
	IR : 500Mohm or 25Mohm · μF					
	Whichever is Smaller					
High Temperature	Capacitance change :	With 200% of the rated voltage				
Resistance	within ±3% or ±0.3pF whichever is larger	Max. operating temperature				
	Q: 350 min	1000+48/-0hrs				
	IR : 1000Mohm or 50Mohm ⋅ μF					
	Whichever is Smaller					
Temperature	Capacitance change :	1 cycle condition				
Cycling	within ±2.5% or ±0.25pF whichever is larger	Min. operating temperatur  → 25°C				
	Tan δ, IR : initial spec.	$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}\!$				
		5 cycle test				

#### C. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260+0/-5  $^{\circ}\mathrm{C}$  , 10sec. Max )

<sup>\*</sup> For the more detail Specification, Please refer to the Samsung MLCC catalogue.